

February 2012



Automotive Recommended Product Selector Guide

Featuring:
8- and 16-bit PIC® Microcontrollers
dsPIC® Digital Signal Controllers
Analog & Interface Products
Serial EEPROMs
Real-Time Clock/Calendars
Flash Memory

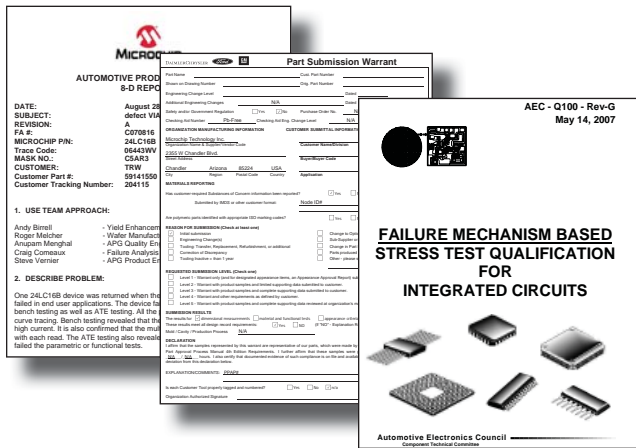


Microchip: A Partner in Your Automotive Success

Microchip is a leading provider of microcontroller and analog semiconductors, providing low-risk product development, lower total system cost and faster time to market for thousands of diverse customer applications worldwide. Offering outstanding technical support along with dependable delivery and quality, Microchip serves over 300 automotive customers globally who are designing high-volume embedded control applications from safety and body modules to security, driver information and powertrain modules.

Commitment to the Relentless Quest for Perfection

“Quality Comes First” is at the top of the list of Guiding Values for Microchip Technology. As an ISO/TS-16949 certified supplier since 2003, Microchip’s Aggregate System uniquely supports our commitment to exceptional quality. In an environment where enterprise wide commitment to continuous improvement is demonstrated and every employee is responsible for quality.



All of the products recommended for automotive use are either Q100 Qualified or Q100 Capable.

Q100 Qualified: Reliability testing that complies with the automotive industry’s AEC-Q100 Rev. G has been successfully completed on the specific device of interest. This includes both device and package tests as required by the AEC-Q100 Rev G specification.

Q100 Capable: Although the specific device of interest has not finished AEC-Q100 Rev G reliability testing, it is designed with the same standards, manufactured at the same locations and with the same equipment, and tested to the same quality standards as numerous other devices that have already completed Q100 qualification.

With nearly 20 years of experience in serving the demanding requirements of the automotive customer, Microchip Technology has a proven track record of success in delivering the total product solution to our valued customers that is cost effective and reliable.

Microchip supports various automotive quality initiatives:

- Zero Defect Initiatives
- APQP – Advanced Product/Process Quality Planning
- AEC-Q100 Stress Testing
- PPAP – Production Part Approval Process
- 8D Reporting
- Product Change Notification

www.microchip.com/quality



**Corporate Headquarters
Chandler, Arizona**



**Product Assembly/Test
Bangkok, Thailand**



Fab 2 - Tempe, Arizona



Fab 4 - Gresham, Oregon

Table of Contents

8-bit PIC® Microcontrollers	3	Power Management	15
16-bit PIC Microcontrollers (PIC24F).....	9	Linear	17
16-bit PIC Microcontrollers (PIC24H/E)	11	Mixed Signal	17
dsPIC30F DSC Families	12	Interface	18
dsPIC33 DSC SMPS and Digital Power Conversion Family.....	13	Real-Time Clocks.....	19
dsPIC33 DSC General Purpose Family.....	13	Serial Memory Products.....	19
dsPIC33 DSC Motor Control and Power Conversion Family....	14	Terms and Definitions	20
Analog and Interface Products		SST Parallel Flash and Serial Flash Memory Products	21
Thermal Management	15	Product Packages.....	22

8-bit PIC® Microcontrollers

Product	Released (R) Not Released (NR)	Pins		Core	Memory				Voltage Range	Operating Speed		LCD Segments	mTouch™ Channels	Analog Sensing & Measurement				Digital				Communication						Monitors		High Temperature (150°C)	Packages (Designator)	Special Features							
		Total	I/O		Program	Self-Read	Self-Write	Data RAM (B)		Data EE (B)	Maximum Speed			Internal Oscillator	Charge Time Measurement Unit	8-bit ADC	10-bit ADC	12-bit ADC	Comparators	CCP	ECPP	8-bit Timer	16-bit Timer	AUSART	EUSART	IC™	SPI	Ethernet (MAC/PHY)	FS-USB				ECAN	BOR/PBOR	PLVD	SR-Latch	Timer 1 Gate		
64-Pin (Cont.)	PIC18F67J90/3	R	64	51	PIC18	128 KB 64 Kw	✓	✓	3900	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	132	12	✓	-	12	2	2	-	1	3	1	1	1	1	-	-	-	BOR	✓	-	-	-	TOFP (PT)	Integrated LCD Driver, RTCC	64-Pin (Cont.)	
	PIC18F67K90	R	64	53	PIC18	128 KB 64 Kw	✓	✓	4096	1024	1.8V-5.5V	64 MHz	31 kHz, 500 kHz, 16 MHz	132	16	✓	-	-	16	3	7	3	6	5	-	2	2	2	-	-	-	BOR	✓	-	-	-	QFN (MR), TOFP (PT)		Integrated LCD Driver, XLP
	PIC18F67J50	R	64	49	PIC18	128 KB 64 Kw	✓	✓	3904	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	8	-	-	8	-	2	2	3	2	3	-	2	2	2	-	1	-	BOR	✓	-	-	-	TOFP (PT)		USB 2.0 (Full Speed)
80-Pin	PIC18F85K22	R	80	69	PIC18	32 KB 16 Kw	✓	✓	2048	1024	1.8V-5.5V	64 MHz	31 kHz, 500 kHz, 16 MHz	24	✓	-	-	24	3	5	3	4	4	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	XLP		
	PIC18F85K90	R	80	69	PIC18	32 KB 16 Kw	✓	✓	2048	1024	1.8V-5.5V	64 MHz	31 kHz, 500 kHz, 16 MHz	192	24	✓	-	-	24	3	5	3	4	4	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	Integrated LCD Driver, XLP	
	PIC18F85J50	R	80	65	PIC18	32 KB 16 Kw	✓	✓	3904	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	-	-	-	12	-	2	2	3	2	3	-	2	2	2	-	1	-	BOR	✓	-	-	-	TOFP (PT)	USB 2.0 (Full Speed)	
	PIC18F86J11	R	80	66	PIC18	64 KB 32 Kw	✓	✓	3904	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	-	-	-	15	-	2	2	3	2	3	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	-	
	PIC18F86J90/3	R	80	67	PIC18	64 KB 32 Kw	✓	✓	3900	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	192	12	✓	-	12	2	2	-	1	3	1	1	1	1	-	-	-	BOR	✓	-	-	-	TOFP (PT)	Integrated LCD Driver, RTCC		
	PIC18F86K22	R	80	69	PIC18	64 KB 32 Kw	✓	✓	4096	1024	1.8V-5.5V	64 MHz	31 kHz, 500 kHz, 16 MHz	24	✓	-	-	24	3	7	3	6	5	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	XLP		
	PIC18F86K90	R	80	69	PIC18	64 KB 32 Kw	✓	✓	4096	1024	1.8V-5.5V	64 MHz	31 kHz, 500 kHz, 16 MHz	192	24	✓	-	-	24	3	7	3	6	5	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	Integrated LCD Driver, XLP	
	PIC18F86J50	R	80	65	PIC18	64 KB 32 Kw	✓	✓	3904	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	-	-	-	12	-	2	2	3	2	3	-	2	2	2	-	1	-	BOR	✓	-	-	-	TOFP (PT)	USB 2.0 (Full Speed)	
	PIC18F87J11	R	80	66	PIC18	128 KB 64 Kw	✓	✓	3904	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	-	-	-	15	-	2	2	3	2	3	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	-	
	PIC18F87K22	R	80	69	PIC18	128 KB 64 Kw	✓	✓	4096	1024	1.8V-5.5V	64 MHz	31 kHz, 500 kHz, 16 MHz	24	✓	-	-	24	3	7	3	6	5	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	XLP		
	PIC18F87J90/3	R	80	67	PIC18	128 KB 64 Kw	✓	✓	3900	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	192	12	✓	-	12	2	2	-	1	3	1	1	1	1	-	-	-	BOR	✓	-	-	-	TOFP (PT)	Integrated LCD Driver, RTCC		
	PIC18F87K90	R	80	69	PIC18	128 KB 64 Kw	✓	✓	4096	1024	1.8V-5.5V	64 MHz	31 kHz, 500 kHz, 16 MHz	192	24	✓	-	-	24	3	7	3	6	5	-	2	2	2	-	-	-	BOR	✓	-	-	-	TOFP (PT)	Integrated LCD Driver, XLP	
	PIC18F87J50	R	80	65	PIC18	128 KB 64 Kw	✓	✓	3904	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	-	-	-	-	12	-	2	2	3	2	3	-	2	2	2	-	1	-	BOR	✓	-	-	-	TOFP (PT)	USB 2.0 (Full Speed)	
	PIC18F86J60	R	80	55	PIC18	128 KB 64 Kw	✓	✓	3808	-	2V-3.6V	42 MHz	32 kHz, 31 kHz	-	-	-	-	15	-	2	2	3	2	3	-	2	1	1	1	-	-	BOR	✓	-	-	-	TOFP (PT)	Integrated MAC, 10 Base T PHY	
	PIC18F86J72	R	80	51	PIC18	64 KB 32 Kw	✓	✓	3923	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	132	12	✓	-	-	12	2	2	-	1	3	1	1	1	1	-	-	-	BOR	✓	-	-	-	TOFP (PT)	2x 24-bit ADC, RTCC	
PIC18F87J72	R	80	51	PIC18	128 KB 64 Kw	✓	✓	3923	-	2V-3.6V	48 MHz	8 MHz, 31 kHz	132	12	✓	-	-	12	2	2	-	1	3	1	1	1	1	-	-	-	BOR	✓	-	-	-	TOFP (PT)	2x 24-bit ADC, RTCC		

Products sorted by pin count.

All devices are Pb-Free and RoHS compliant.

♦ - Software PLVD implemented via ADC.

Ⓜ - eXtreme Low Power variants available.

* Integrated Temperature Indicator - Reference Application Note AN1333 for implementation.

AEC-Q100 Qualified AEC-Q100 Capable

Visit the Microchip Automotive Design Center for:

Application Solutions

- Body Electronics
 - Wiper Control System
- Chassis
 - Angular Position Sensor Control
- Drivers Assistance
 - Electronic Compass System
 - Camera Vision System
- Instrumentation
 - Instrument Cluster
- Lighting Control
 - LED Ambient Lighting
- Powertrain
 - Capacitive Discharge Ignition
- Safety/Security
 - Passive Keyless Entry
 - Remote Keyless Entry

Design Resources

- Dev Tools/Ref Design
- Software Library/Code Examples

Microchip in Automotive

- Press Releases
- Technical Articles
- Brochures



www.microchip.com/automotive

dsPIC30F DSC Families

Product	Released (R) Not Released (NR)	IO Pins	Core	Memory			Voltage Range	Operating Speed		Analog			Output Compare/PWM	Input Capture	Motor Control PWM Ch	Power Supply PWM Ch	OEI	Codec (FS, AC97)	16-bit Timer ⁽¹⁾	Communication		High Temperature (150°C)	Monitors		Packages (Designator)
				Program KB	Data RAM (B)	EEPROM		Maximum Speed MIPS	Internal Oscillator	ADC	DAC	Comparators								Digital Communication	CAN		System Mgmt. Features		
dsPIC30F3012	R	12	dsPIC	24	2048	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	8 x 12-bit @ 200 (ksps)	-	-	2	2	-	-	-	-	3	1 UART, 1 SPI, 1 I ² C	-	-	PBOR, LVD, POR, WDT	PDIP (P), SOIC (SO), QFN (ML)	18-Pin
dsPIC30F2010	R	20	dsPIC	12	512	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	6 x 10-bit @ 1000 (ksps)	-	-	2	4	6	-	1	-	3	1 UART, 1 SPI, 1 I ² C	-	-	PBOR, LVD, POR, WDT	SOIC (SO), SPDIP (SP), QFN (ML), PDIP (P)	28-Pin
dsPIC30F3013	R	20	dsPIC	24	2048	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	10 x 12-bit @ 200 (ksps)	-	-	2	2	-	-	-	-	3	2 UART, 1 SPI, 1 I ² C	-	-	PBOR, LVD, POR, WDT	SOIC (SO), SPDIP (SP), QFN (ML)	28-Pin
dsPIC30F4012	R	20	dsPIC	48	2048	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	6 x 10-bit @ 1000 (ksps)	-	-	2	4	6	-	1	-	5	1 UART, 1 SPI, 1 I ² C	1	-	PBOR, LVD, POR, WDT	SOIC (SO), SPDIP (SP), QFN (ML)	40-Pin
dsPIC30F4013	R	30	dsPIC	48	2048	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	13 x 12-bit @ 200 (ksps)	-	-	4	4	-	-	-	1	5	2 UART, 1 SPI, 1 I ² C	1	-	PBOR, LVD, POR, WDT	PDIP (P), TOFP (PT), QFN (ML)	40-Pin
dsPIC30F4011	R	30	dsPIC	48	2048	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	9 x 10-bit @ 1000 (ksps)	-	-	4	4	6	-	1	-	5	2 UART, 1 SPI, 1 I ² C	1	-	PBOR, LVD, POR, WDT	PDIP (P), TOFP (PT), QFN (ML)	40-Pin
dsPIC30F5015	R	52	dsPIC	66	2048	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	16 x 10-bit @ 1000 (ksps)	-	-	4	4	8	-	1	-	5	1 UART, 2 SPI, 1 I ² C	1	-	PBOR, LVD, POR, WDT	TOFP (PT)	64-Pin
dsPIC30F6011A	R	52	dsPIC	132	6144	2048	2.5V-5.5V	30	7.37 MHz, 32 kHz	16 x 12-bit @ 200 (ksps)	-	-	8	8	-	-	-	-	5	2 UART, 2 SPI, 1 I ² C	2	-	PBOR, LVD, POR, WDT	TOFP (PT)	64-Pin
dsPIC30F5016	R	68	dsPIC	66	2048	1024	2.5V-5.5V	30	7.37 MHz, 32 kHz	16 x 10-bit @ 1000 (ksps)	-	-	4	4	8	-	1	-	5	1 UART, 2 SPI, 1 I ² C	1	-	PBOR, LVD, POR, WDT	TOFP (PF)	80-Pin
dsPIC30F6014A	R	68	dsPIC	144	8192	4096	2.5V-5.5V	30	7.37 MHz, 32 kHz	16 x 12-bit @ 200 (ksps)	-	-	8	8	-	-	-	1	5	2 UART, 2 SPI, 1 I ² C	2	-	PBOR, LVD, POR, WDT	TOFP (PF)	80-Pin
dsPIC30F6010A	R	68	dsPIC	144	8192	4096	2.5V-5.5V	30	7.37 MHz, 32 kHz	16 x 10-bit @ 1000 (ksps)	-	-	8	8	8	-	1	-	5	2 UART, 2 SPI, 1 I ² C	2	-	PBOR, LVD, POR, WDT	TOFP (PF)	80-Pin

Note 1: Two 16-bit timers can be concatenated to form a 32-bit timer.

dsPIC33 DSC SMPS and Digital Power Conversion Family

Product	Released (R) Not Released (NR)	IO Pins	Core	Memory				Voltage Range	Operating Speed		Analog			Output Compare/PWM	Input Capture	Power Supply PWM Ch ⁽¹⁾	OEI	16-bit Timer ⁽²⁾	Communication		PMP	RTCC	PPS	High Temperature (150°C)	Monitors		Packages (Designator)
				Program KB	Data RAM (B)	EEPROM	DMA #Ch		Maximum Speed MIPS	Internal Oscillator	ADC 10-bit 2000/4000 Ksps	DAC	Comparators						Digital Communication	CAN					System Mgmt. Features		
dsPIC33FJ06GS101	R	13	dsPIC*	6	256	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	6 ch	-	-	1	-	4	-	2	1 UART, 1 SPI, 1 I ² C	-	-	-	✓	-	BOR, POR, WDT	SOIC (SO)	18-Pin
dsPIC33FJ06GS102	R	21	dsPIC	6	256	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	6 ch	-	-	1	-	4	-	2	1 UART, 1 SPI, 1 I ² C	-	-	-	✓	-	BOR, POR, WDT	QFN (MM), SOIC(SO), SPDIP (SP)	28-Pin
dsPIC33FJ06GS202	R	21	dsPIC	6	1024	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	6 ch	2 x 10-bit	2	1	1	4	-	2	1 UART, 1 SPI, 1 I ² C	-	-	-	✓	-	BOR, POR, WDT	QFN (MM), SOIC(SO), SPDIP (SP)	28-Pin
dsPIC33FJ16GS402	R	21	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	8 ch	-	-	2	2	6	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	✓	-	BOR, POR, WDT	QFN (MM), SOIC (SO), SPDIP (SP)	28-Pin
dsPIC33FJ16GS502	R	21	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	8 ch, 2 ADC*	4 x 10-bit	4	2	2	8	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	✓	-	BOR, POR, WDT	QFN (MM), SOIC (SO), SPDIP (SP)	28-Pin
dsPIC33FJ16GS404	R	35	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	8 ch	-	-	2	2	6	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	✓	-	BOR, POR, WDT	QFN (ML), TOFP (PT)	44-Pin
dsPIC33FJ16GS504	R	35	dsPIC	16	2048	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	12 ch, 2 ADC*	4 x 10-bit	4	2	2	8	-	3	1 UART, 1 SPI, 1 I ² C	-	-	-	✓	-	BOR, POR, WDT	QFN (ML), TOFP (PT)	44-Pin
dsPIC33FJ32GS406	R	58	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	16 ch	-	-	4	4	12	1	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	-	BOR, POR, WDT	QFN (MR), TOFP (PT)	64-Pin
dsPIC33FJ64GS406	R	58	dsPIC	64	8192	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	16 ch	-	-	4	4	12	1	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	-	BOR, POR, WDT	QFN (MR), TOFP (PT)	64-Pin
dsPIC33FJ32GS606	R	58	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	16 ch, 2 ADC*	4 x 10-bit	4	4	4	12	2	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	-	BOR, POR, WDT	QFN (MR), TOFP (PT)	64-Pin
dsPIC33FJ64GS606	R	58	dsPIC	64	9216	AN1095 ⁽¹⁾	4	3V-3.6V	40	7.37 MHz, 32 kHz	16 ch, 2 ADC*	4 x 10-bit	4	4	4	12	2	5	2 UART, 2 SPI, 2 I ² C	1	-	-	-	-	BOR, POR, WDT	QFN (MR), TOFP (PT)	64-Pin
dsPIC33FJ32GS608	R	74	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	18 ch, 2 ADC*	4 x 10-bit	4	4	4	16	2	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	-	BOR, POR, WDT	TOFP (PT)	80-Pin
dsPIC33FJ64GS608	R	74	dsPIC	64	9216	AN1095 ⁽¹⁾	4	3V-3.6V	40	7.37 MHz, 32 kHz	18 ch, 2 ADC*	4 x 10-bit	4	4	4	16	2	5	2 UART, 2 SPI, 2 I ² C	1	-	-	-	-	BOR, POR, WDT	TOFP (PT)	80-Pin
dsPIC33FJ32GS610	R	85	dsPIC	32	4096	AN1095 ⁽¹⁾	-	3V-3.6V	40	7.37 MHz, 32 kHz	24 ch, 2 ADC*	4 x 10-bit	4	4	4	18	2	5	2 UART, 2 SPI, 2 I ² C	-	-	-	-	-	BOR, POR, WDT	TOFP (PF, PT)	100-Pin
dsPIC33FJ64GS610	R	85	dsPIC	64	9216	AN1095 ⁽¹⁾	4	3V-3.6V	40	7.37 MHz, 32 kHz	24 ch, 2 ADC*	4 x 10-bit	4	4	4	18	2	5	2 UART, 2 SPI, 2 I ² C	1	-	-	-	-	BOR, POR, WDT	TOFP (PF, PT)	100-Pin

Note 1: See Application Note *AN1095 - Emulating Data EEPROM.

2: Two 16-bit timers can be concatenated to form a 32-bit timer.

All devices are Pb-Free and RoHS compliant.

AEC-Q100 Qualified AEC-Q100 Capable

Thermal Management – Temperature Sensors

Product	Typical Accuracy (°C)	Max. Accuracy @ 25°C (°C)	Max. Temperature Range (°C)	High Temperature (150°C)	Vcc Range (V)	Max. Op Current (µA)	Features	Packages
MCP9501/2/3/4	±0.5	±3	-55 to +125	-	+2.7 to +5.5	40	Cross to MAX6501/2/3/4, Open-drain and push-pull output options	SOT-23A
MCP9509/10	±0.5	NS	-40 to +125	-	+2.7 to +5.5	50	Resistor-programmable temperature switch	SOT-23A
MCP9700/01	±1	±4	-40 to +150	✓	+2.3 to +5.5	12	Linear Active Thermistor® IC	SOT-23A, TO-92, SC70
MCP9700/01A	±1	±2	-40 to +125	-	+2.3 to +5.5	12	Linear Active Thermistor® IC	SOT-23A, TO-92, SC70
TC1046	±0.5	±2	-40 to +125	-	+2.7 to +4.4	60	High precision temperature-to-voltage converter, 6.25 mV/°C	SOT-23A
TC1047A	±0.5	±2	-40 to +125	-	+2.5 to +5.5	60	High precision temperature-to-voltage converter, 10 mV/°C	SOT-23A
MCP9800/1/2/3	±0.5	±1	-55 to +125	-	+2.7 to +5.5	400	SMBus/I ² C™ compatible interface, 0.0625°C to 0.5°C adj. resolution, power-saving one-shot temperature measurement	SOIC, MSOP, SOT-23A
MCP9804	±0.25	±1	-40 to +125	-	+2.7 to +5.5	400	User programmable temperature limits with alert output, 1°C temp. accuracy from -40°C to +125°C	MSOP, DFN
MCP9843	±0.5	±1	-20 to +125	-	+3.0 to +3.6	400	JEDEC compatible register set, SMBus/I ² C™ compatible interface, programmable, shut-down modes and EVENT output	TSSOP, DFN
MCP98243	±1	±3	-40 to +125	-	+3.0 to +3.6	500	Serial output temperature sensor with integrated EEPROM	TSSOP, DFN, TDFN

Power Management – Switching Regulators/PWM Controllers

Product	Input Voltage Range (V)	Output Voltage (V)	Operating Temperature Range (°C)	Control Scheme	Switching Frequency (kHz)	Typical Active Current (µA)	Output Current (mA)	Features	Packages
MCP1630V/1631V	3.0 to 5.5	-	-40 to +125	PWM	1000/2000	2800/3700	Ext	Current/Voltage mode PWM controller, UVLO, Short Circuit and Over-temperature Protection, Integrated MOSFET driver	MSOP, SSOP, TSSOP, DFN
MCP1631HV/VHV	3.5 to 16	-	-40 to +125	PWM	2000	3700	Ext	Current/Voltage mode PWM controller with integrated 16V LDO, UVLO, Integrated error, current and voltage sense amplifier, overvoltage comparator and MOSFET driver	SSOP, TSSOP
TC1303/04/13	2.7 to 5.5	DC/DC: 0.8 to 4.5 LDO: 1.5 to 3.3	-40 to +85	PFM/PWM	2000	65/600	DC/DC: 500 mA LDO: 300 mA	Synchronous Buck Regulator, LDO w/Power Good with PFM/PWM auto-switching, Power Good output or Power Sequencing	MSOP, DFN
MCP1602/3	2.7 to 5.5	0.8 to 4.5 / 4.0	-40 to +85	PFM/PWM	2000	35/45	500	Synchronous Buck Regulator PFM, PWM auto-switching, UVLO, soft start, Power Good indicator, Over-temperature/current protection	MSOP, DFN, TSOT
MCP1640/B/C/D	0.65 to 6	2.0 to 5.5	-40 to +85	PWM or PWM/PPM	500	19	350	Integrated synchronous boost regulator, -65V start-up voltage, soft-start, True load disconnect or input-to-output bypass option	SOT-23, DFN
MCP1650/1/2/3	2.7 to 5.5	2.5 to ext. tx limited	-40 to +125	Constant Frequency	750	120	560/440	Step-up DC/DC Controller with shutdown control, low battery detect, Power Good indicator, UVLO, soft start	MSOP

Power Management – Linear Regulators

Product	Max. Input Voltage (V)	Output Voltage (V)	Output Current (mA)	Typical Active Current (µA)	Typical Dropout Voltage @ Max. I _{out} (mV)	Typical Output Voltage Accuracy (%)	Features	Packages
TC1016/17	6	1.8 to 4.0	80/150	53	150/285	±0.5	Shutdown	SOT-23A, SC70
TC2014/5, TC2185	6	1.8 to 5.0	50/100/150	55	45/90/140	±0.4	Shutdown, Reference bypass input	SOT-23A
TC2054/5, TC2186	6	1.8 to 5.0	50/100/150	55	45/90/140	±0.4	Shutdown, Error output	SOT-23A
MCP1790/1	30	3.0, 3.3, 5.0	70	70	500	±0.2	Load dump, Shutdown, Power Good	SOT-223, DDPACK
MCP1700	6	1.2 to 5.0	250	1.6	300	±0.4	Very low I _o	SOT-23A, SOT-89, TO-92
MCP1702/3	13.2/16	1.2 to 5.0	250	2	330/625	±0.4	Very low I _o	DFN, TO-92, SOT-23A, SOT-89, SOT-223
MCP1824/5/6/7	6	0.8 to 5.0	300/500/1000/1500	120/120/140/140	200/210/300/330	±0.5	Fixed and Adjustable output, Shutdown, Power Good	SOT-23, SOT-223, TO-220, DDPACK
MCP1824S/5S/6S/7S	6	0.8 to 5.0	300/500/1000/1500	120/120/140/140	200/210/300/330	±0.5	3-pin high current LDOs	SOIC, DFN, SOT-223, TO-220, DDPACK
MCP1725/6/7	6	0.8 to 5.0	500/1000/1500	120/140/140	210/300/330	±0.5	Shutdown, C _{DELAY} , Power Good	SOIC, DFN
TC1301A/B	6	1.5 to 3.3	LDO1: 300 LDO2: 150	103/114	LDO1: 104 LDO2: 150	±0.5	Dual LDO plus Reset output, Shutdown, Reference bypass, Voltage detect	MSOP, DFN
TC1302A/B	6	1.5 to 3.3	LDO1: 300 LDO2: 150	103/114	LDO1: 104 LDO2: 150	±0.5	Dual LDO, Shutdown, Reference bypass, Voltage detect	MSOP, DFN

Power Management – Charge Pump DC-to-DC Converters

Product	Input Voltage Range (V)	Output Voltage (V)	Operating Temp Range (°C)	Max. Input Current (µA)	Typical Output Current (mA)	Features	Packages
TC1044S	1.5 to 12	-V _{IN} or 2*V _{IN}	-40 to +85	160	20	85 kHz oscillator Boost mode	PDIP, SOIC
TC7660	1.5 to 10	-V _{IN} or 2*V _{IN}	-40 to +85	180	20	10 kHz oscillator	PDIP, SOIC
TC7660H	1.5 to 10	-V _{IN} or 2*V _{IN}	-40 to +85	1000	20	120 kHz oscillator	PDIP, SOIC
TC7660S	1.5 to 12	-V _{IN} or 2*V _{IN}	-40 to +85	160	20	45 kHz oscillator Boost mode	PDIP, SOIC
TC7662B	1.5 to 15	-V _{IN} or 2*V _{IN}	-40 to +85	180	20	35 kHz oscillator Boost mode	PDIP, SOIC
TC7662A	3.0 to 18	-V _{IN} or 2*V _{IN}	-40 to +85	200	40	12 kHz oscillator	PDIP, SOIC
MCP1256	1.8 to 3.6	3.3	-40 to +85	100	100	Power Good Sleep mode	MSOP, DFN
MCP1257	1.8 to 3.6	3.3	-40 to +85	100	100	Sleep mode low battery indication	MSOP, DFN
MCP1258	1.8 to 3.6	3.3	-40 to +85	100	100	Low battery indication input/output bypass 1	MSOP, DFN

Power Management – CPU/System Supervisors

Product	Description	Operating Temp Range (°C)	Features	Packages
MCP11(1/2)	System Voltage Detectors	-40 to +125	Wide V _{CC} Input Range, Wide Detection Range (Custom Options Available), Low Current, CMOS/Push-Pull Active Low Reset Options	3/SOT-23A, 3/SOT-89, 3/SC-70
MCP809, MCP100, MCP130, MCP120 MCP13XX, TC1270A and more	System Voltage Supervisors (Available Reset Delays)	-40 to +125 -40 to +85	Wide Detection Range (Custom Options Available), Low Current, Push-Pull/Open Drain, Active High/Low, Watchdog, Manual Reset, Dual Output Options, Multiple Reset Delay Options	3/SOT-23, 3/TO-92, 3/SC-70, 8/SOIC 150mil, 5/SOT-23, 4/SOT-143

Power Management – Power MOSFET Drivers

Product	Configuration	Operating Temp Range (°C)	Peak Output Current (A)	Output Resistance (Max. @ 25°C)	Max Supply Voltage (V)	Input/Output Delay (ns)	Packages
MCP1401/02 Single	Inverting/Non-inverting	-40 to +125	0.5	18/16	18	40/40	SOT-23
MCP1415/16 Single	Inverting/Non-inverting	-40 to +125	1.5	7.5/5.5	18	50/55	SOT-23
TC4467/8/9 Quad	Inverting/ Non-inverting	-40 to +85	1.2	15/15	18	40/40	PDIP, SOIC
TC4426A/27A/28A Dual	Inverting/Non-inverting	-40 to +125	1.5	9/9	18	30/30	PDIP, SOIC, DFN
TC4423A/24A/25A Dual	Inverting/Non-inverting	-40 to +125	3	3 (typ.)/4 (typ.)	18	40 (typ.)/40 (typ.)	PDIP, SOIC, DFN
MCP14E3/E4/E5 Dual	Inverting/Non-inverting	-40 to +125	4	3.5/3.0	18	55/55	PDIP, SOIC, DFN
MCP14E6/E7/E8 Dual	Inverting/Non-inverting/Inverting and Non-inverting	-40 to +125	2	2.2/2.8	18	45/45	PDIP, SOIC, DFN
MCP14E9/E10/E11 Dual	Inverting/Non-inverting/Inverting and Non-inverting	-40 to +125	3	2.2/2.8	18	75/75	PDIP, SOIC, DFN
MCP1406/07 Single	Inverting/Non-inverting	-40 to +125	6	1.8/2.0 (typ.)	18	30/30	TO-220, PDIP, DFN, SOIC
TC4420/29	Inverting/Non-inverting	-40 to +125	6	2.8/2.5	18	55/55	TO-220, PDIP, DFN, SOIC
TC4421A/22A Single	Inverting /Non-inverting	-40 to +125	9	1.25 (typ.)/1.5	18	38/42	PDIP, SOIC, TO-220, DFN
TC4451/52 Single	Inverting /Non-inverting	-40 to +125	12	0.6 (typ.)/1.5	18	15/15	SOIC, PDIP, DFN, TO-220, DDPK
TC4431/32 Single	Inverting /Non-inverting	-40 to +85	1.5	10/10	30	62/78	PDIP, SOIC

Linear – Op Amps

Product	# per Package	GBWP (MHz)	Io Typical (µA)	Vos Max (mV)	Operating Voltage (V)	High Temperature (150°C)	Packages
MCP6612/3/5	1/2/1/2	60	6000	8	2.5 to 5.5	–	SOIC, MSOP, DFN
MCP6512/5	1/2/2	50	6000	0.2	2.5 to 5.5	–	SOIC, MSOP, DFN
MCP6312/3/5	1/2/1/2	24	2500	8	2.5 to 5.5	–	SOIC, MSOP, DFN
MCP6212/5	1/2/2	20	2500	0.2	2.5 to 5.5	–	SOIC, MSOP, DFN
MCP60212/3/4	1/2/1/4	10	1000	0.5	2.5 to 5.5	–	PDIP, SOIC, MSOP, TSSOP, SOT
MCP62912/3/4/5	1/2/1/4/2	10	1000	3	2.4 to 6.0	–	PDIP, SOIC, MSOP, TSSOP, SOT
MCP62812/3/4/5	1/2/1/4/2	5	445	3	2.2 to 6.0	–	PDIP, SOIC, MSOP, TSSOP, SOT
MCP6286	1	3.5	540	1.5	2.2 to 5.5	–	SOT
MCP6012/3/4	1/2/1/4	2.8	230	2	2.7 to 6.0	–	PDIP, SOIC, TSSOP, SOT
MCP62712/3/4/5	1/2/1/4/2	2	170	3	2.0 to 6.0	–	PDIP, SOIC, MSOP, TSSOP, SOT
MCP6V012/3	1/2/1	1.3	300	0.002	1.8 to 5.5	–	SOIC, DFN, TDFN
MCP6V06/7/8	1/2/1	1.3	300	0.003	1.8 to 5.5	–	SOIC, DFN, TDFN
MCP60712/4	1/2/4	1.2	110	0.15	1.8 to 6.0	–	SOIC, TSSOP, DFN, SOT

Product	# per Package	GBWP (MHz)	Io Typical (µA)	Vos Max (mV)	Operating Voltage (V)	High Temperature (150°C)	Packages
MCP60012/4	1/2/4	1	100	4.5	1.8 to 6.0	–	PDIP, SOIC, MSOP, TSSOP, TDFN, SOT, SC70
MCP64012/4	1/2/4	1	45	4.5	1.8 to 6.0	✓	SOIC, TSSOP, TDFN, SOT, SC70
MCP60612/4	1/2/4	0.73	60	0.15	1.8 to 6.0	–	SOIC, TSSOP, DFN, SOT
MCP62412/4	1/2/4	0.55	50	5	1.8 to 5.5	–	PDIP, SOIC, MSOP, TSSOP, TDFN, SOT, SC70
MCP60512/4	1/2/4	0.385	30	0.15	1.8 to 6.0	–	SOIC, TSSOP, DFN, SOT
MCP62312/4	1/2/4	0.3	20	5	1.8 to 6.0	–	PDIP, SOIC, MSOP, TSSOP, TDFN, SOT, SC70
MCP616/7/8/9	1/2/1/4	0.19	19	0.15	2.3 to 5.5	–	PDIP, SOIC, MSOP, TSSOP
MCP606/7/8/9	1/2/1/4	0.155	19	0.25	2.5 to 6.0	–	PDIP, SOIC, TSSOP, SOT
MCP61412/3/4	1/2/1/4	0.1	0.6	3	1.4 to 6.0	–	PDIP, SOIC, MSOP, TSSOP, SOT
MCP60412/3/4	1/2/1/4	0.014	0.6	3	1.4 to 6.0	–	PDIP, SOIC, MSOP, TSSOP, SOT
MCP60312/3/4	1/2/1/4	0.01	0.9	0.15	1.8 to 5.5	–	SOIC, MSOP, TSSOP, DFN, SOT
MCP6441	1	0.009	0.45	4.5	1.4 to 6.0	–	SOT, SC70

Linear – Comparators

Product	# per Package	Typical Propagation Delay (µs)	Io Typical (µA)	Vos Max (mV)	Operating Voltage (V)	Temperature Range (°C)	Features	Packages
MCP65412/3/4	1/2/1/4	4	1	5	1.6 to 5.5	-40 to +125	Push-Pull, Rail-to-Rail Input/Output	PDIP, SOIC, MSOP, TSSOP, SOT, SC70
MCP6546/7/8/9	1/2/1/4	4	1	5	1.6 to 5.5	-40 to +125	Open-drain, 9V, Rail-to-Rail Input/Output	PDIP, SOIC, MSOP, TSSOP, SOT, SC70
MCP65R41/6	1	4	2.5	10	1.8 to 5.5	-40 to +125	Integrated Vref (1.21V or 2.4V)	SOT-23
MCP65612/4	1/2/4	0.047	100	10	1.8 to 5.5	-40 to +125	Push-Pull, Rail-to-Rail Input/Output	SOIC, MSOP, TSSOP, SOT, SC70
MCP6566/7/9	1/2/4	0.047	100	10	1.8 to 5.5	-40 to +125	Open-Drain, Rail-to-Rail Input/Output	SOIC, MSOP, TSSOP, SOT, SC70

Mixed Signal – Successive Approximation Register (SAR) Analog-to-Digital Converters

Product	Resolution (bits)	Maximum Sampling Rate (ksamples/sec)	# of Input Channels	Input Type	Interface	Max. Supply Current (µA)	Temperature Range (°C)	Packages
MCP3021/3221	10/12	22	1	Single-ended	I ² C™	250	-40 to +125	SOT-23A
MCP30012/4/8	10	200	1/2/4/8	Single-ended	SPI	500-550	-40 to +85	PDIP, SOIC, MSOP, TSSOP
MCP32012/4/8	12	100	1/2/4/8	Single-ended	SPI	400-550	-40 to +85	PDIP, SOIC, MSOP, TSSOP
MCP33012/4	13	100	1/2/4	Differential	SPI	450	-40 to +85	PDIP, SOIC, MSOP, TSSOP

Mixed Signal – Energy Measurement ICs

Product	Dynamic Range	Typical Accuracy	ADC Channels	Gain Selection	Output Type	Typical Supply Current (mA)	Analog Voltage Range (V)	Digital Voltage Range (V)	Temperature Range (°C)	Packages
MCP3901	24-bit resolution	91 dB SINAD	2	up to 32	SPI	2.6	4.5 to 5.5	2.7 to 5.5	-40 to +125	SSOP, QFN
MCP3903	24-bit resolution	91 dB SINAD	6	up to 32	SPI	8.3	4.5 to 5.5	2.7 to 3.6	-40 to +125	SSOP
MCP3905A/06A	500:1 /1000:1	0.1%	2	up to 32	Active power pulse	3.9	4.5 to 5.5	4.5 to 5.5	-40 to +125	SSOP
MCP3909	1000:1	0.1%	2	up to 16	Active power pulse/SPI	3.9	4.5 to 5.5	4.5 to 5.5	-40 to +125	SSOP

Mixed Signal – Digital-to-Analog Converters

Product	Resolution (Bits)	DAC Channels	Interface	Voltage Reference	Output Settling Time (µs)	DNL (±LSB)	Typical Operating Current (µA)	Temperature Range (°C)	Packages
MCP4725	12	1	I ² C™	V _{DD}	6	0.75	175	-40 to +125	SOT-23
MCP4728	12	4	I ² C™	Int	6	0.75	250	-40 to +125	MSOP
MCP4801/11/21	8/10/12	1	SPI	Int	4.5	0.5/0.5/0.75	330	-40 to +125	2x3 DFN, MSOP, PDIP, SOIC
MCP4802/12/22	8/10/12	2	SPI	Int	4.5	0.5/0.5/0.75	415	-40 to +125	MSOP, PDIP, SOIC
MCP4901/11/21	8/10/12	1	SPI	Ext	4.5	0.5/0.5/0.75	175	-40 to +125	2x3 DFN, MSOP, PDIP, SOIC
MCP4902/12/22	8/10/12	2	SPI	Ext	4.5	0.5/0.5/0.75	350	-40 to +125	PDIP, SOIC, TSSOP

AEC-Q100 Qualified AEC-Q100 Capable

All devices are Pb-Free and RoHS compliant.

Mixed Signal – Digital Potentiometers

Product	# of Taps	Memory	Channels	Interface	Resistance (kΩ)	Temperature Range (°C)	Packages	Product	# of Taps	Memory	Channels	Interface	Resistance (kΩ)	Temperature Range (°C)	Packages
MCP4011/12/13/14	64	Volatile	1	Up/Down	2.1, 5, 10, 50	-40 to +125	DFN, SOT-23	MCP4331/32	129	Volatile	4	SPI	5, 10, 50, 100	-40 to +125	TSSOP, QFN
MCP4017/18/19	128	Volatile	1	I ² C™	5, 10, 50, 100	-40 to +125	SC-70	MCP4351/52	257	Volatile	4	SPI	5, 10, 50, 100	-40 to +125	TSSOP, QFN
MCP40D17/D18/D19	128	Volatile	1	I ² C™	5, 10, 50, 100	-40 to +125	SC-70	MCP4431/32	129	Volatile	4	I ² C™	5, 10, 50, 100	-40 to +125	TSSOP, QFN
MCP4021/22/23/24	64	Nonvolatile	1	Up/Down	2.1, 5, 10, 50	-40 to +125	DFN, SOT-23	MCP4441/42	129	Nonvolatile	4	I ² C™	5, 10, 50, 100	-40 to +125	TSSOP, QFN
MCP4141/42	128	Nonvolatile	1	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN	MCP4451/52	257	Volatile	4	I ² C™	5, 10, 50, 100	-40 to +125	TSSOP, QFN
MCP4241/42	128	Nonvolatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN	MCP4461/62	257	Nonvolatile	4	I ² C™	5, 10, 50, 102	-40 to +125	TSSOP, QFN
MCP4131/32	128	Volatile	1	SPI	5, 10, 50, 100	-40 to +125	QFN, DFN	MCP4531/32	128	Volatile	1	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN
MCP4231/32	128	Volatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN	MCP4631/32	128	Volatile	2	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN
MCP4151/52	256	Volatile	1	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN	MCP4541/42	128	Nonvolatile	1	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN
MCP4161/62	256	Nonvolatile	1	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN	MCP4641/42	128	Nonvolatile	2	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN
MCP4251/52	256	Volatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN	MCP4551/52	256	Volatile	1	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN
MCP4261/62	256	Nonvolatile	2	SPI	5, 10, 50, 100	-40 to +125	MSOP, QFN, DFN	MCP4651/52	256	Volatile	2	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN
MCP4341/42	129	Nonvolatile	4	SPI	5, 10, 50, 100	-40 to +125	TSSOP, QFN	MCP4561/62	256	Nonvolatile	1	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN
MCP4361/62	257	Nonvolatile	4	SPI	5, 10, 50, 100	-40 to +125	TSSOP, QFN	MCP4661/62	256	Nonvolatile	2	I ² C™	5, 10, 50, 100	-40 to +125	MSOP, DFN

Mixed Signal – Delta Sigma Analog-to-Digital Converters

Product	Resolution (bits)	Maximum Sampling Rate (samples/sec)	# of Input Channels	Interface	Typical Supply Current (μA)	Temperature Range (°C)	Features	Packages
MCP3421/2/3/4	18 to 12	4 to 240	1/2/2/4 Diff	I ² C™	155	-40 to +125	PGA, V _{REF}	SOT, DFN, MSOP, SOIC, TSSOP
MCP3425/6/7/8	16 to 12	15 to 240	1/2/2/4 Diff	I ² C™	155	-40 to +125	PGA, V _{REF}	SOT, DFN, MSOP, SOIC, TSSOP
MCP3550/1/3	22	13/14/60	1 Diff	SPI	120	-40 to +125	50 & 60 Hz Rejection	SOIC, MSOP

Interface – mTouch™ AR1000 Resistive Touch Screen Controllers

Product	Type	Communication	Touch Screens Supported	A/D	Resolution	Power	Points per second	Baud Rate	Operating Temperature Range (°C)	Static Protection	Special Features	Package
AR1010	Analog Resistive	UART	All Manufacturers 4, 5 and 8 wire	Internal 10-bit Ratiometric	1024 X 1024	3.3V DC ±5% 5.5V DC ±5%	140 pps	Standard 9600	-40 to +85	Per schematic	Controller driven calibration & Universal for all touch screens	20-pin SSOP (SS), SOIC (SO), QFN (ML)
AR1020	Analog Resistive	SPI, I ² C™	All Manufacturers 4, 5 and 8 wire	Internal 10-bit Ratiometric	1024 X 1024	3.3V DC ±5% 5.5V DC ±5%	140 pps	Standard 9600	-40 to +85	Per schematic	Controller driven calibration & Universal for all touch screens	20-pin SSOP (SS), SOIC (SO), QFN (ML)

Interface – Controller Area Network (CAN), Infrared, LIN Transceivers, Ethernet, Serial Peripherals, USB

Product	Description	Operating Temperature Range (°C)	Other Features	Packages
MCP2515	Stand-Alone CAN Controller with SPI Interface	-40 to +125	3 TX Buffers, 2 RX Buffers, 6 Filters, 2 Masks, Interrupt output, MCP2510 upgrade	PDIP, SOIC, TSSOP
MCP202(1/2)	LIN (Local Interconnect Network), LIN Transceiver with Voltage Regulator	-40 to +125	V _{REG} = 5.0 ± 3%, 3.3 ± 3% @ 50 mA, V _{CC} Range = 7.4 to 18V, Max Baud Rate = 20 Kbaud, Supports LIN Specs: 1.3, 2.0, 2.1, SAE J2602, Exceeds Automotive OEM ESD/EMC Requirements	PDIP, SOIC, TSSOP, DFN
MCP200(3/4)	Stand-alone LIN Transceiver	-40 to +125	V _{CC} Range = 6 to 27V, Max Baud Rate = 20 Kbaud, Supports LIN Specs 1.3, 2.0, 2.1, SAE J2602, Exceeds Automotive OEM ESD/EMC Requirements	PDIP, SOIC, DFN
MCP23X09/18	8-bit I/O Port Expander, 16-bit I/O Port Expander	-40 to +125	I ² C (up to 3.4 MHz) or SPI (up to 10 MHz) interface, 25 mA source/sink per I/O	PDIP, SDIP, SOIC, SSOP
MCP212(0/2), MCP2140A, MCP215(0/5)	Infrared IrDA® Encoders, Decoders, Protocol Handlers	-40 to +85	UART to IR encoder/decoder w/hardware & software baud rate selection, IrDA Standard protocol handler plus encoder/decoder	PDIP, SDIP, SOIC, SSOP
MCP2200	UART to USB Protocol Converter	-40 to +85	USB 2.0 Compliant, 8 GPIO, Supports High-speed USB (12 Mbps)	SOIC, SSOP, QFN

All devices are Pb-Free and RoHS compliant.

AEC-Q100 Qualified AEC-Q100 Capable

Real-Time Clock/Calendar (RTCC)

Bus	Product	Timing Features				Memory ⁽¹⁾			Power		Unique Features ⁽²⁾	Pins	Packages	Bus
		Digital Trim (Adj/Range)	Alarm Settings	WDT	Outputs	SRAM (Bytes)	EEPROM (Kbits)	ID/MAC (Bits)	Minimum Voltages	I _{BAT} (nA)				
I ² C™ (400 kHz)	MCP7941X	+1 ppm/±127 ppm	2 (1 sec.)	-	MFP (I ² C/CLK)	64	1	64	V _{CC} : 1.8V, V _{BAT} : 1.3V	<700	Power Fail Timestamp	8	SOIC (SN), TSSOP (ST), MSOP (MS), TDFN (MNY)	I ² C™ (400 kHz)
	MCP7940X	+1 ppm/±127 ppm	2 (1 sec.)	-	MFP (I ² C/CLK)	64	0	64	V _{CC} : 1.8V, V _{BAT} : 1.3V	<700	Power Fail Timestamp	8	SOIC (SN), TSSOP (ST), MSOP (MS), TDFN (MNY)	
	MCP7940N	+1 ppm/±127 ppm	2 (1 sec.)	-	MFP (I ² C/CLK)	64	0	0	V _{CC} : 1.8V, V _{BAT} : 1.3V	<700	Power Fail Timestamp	8	SOIC (SN), TSSOP (ST), MSOP (MS), TDFN (MNY)	
SPI (10 MHz)	MCP795W2X	+1 ppm/±255 ppm	2 (0.01 sec)	✓	1. CLK 2. I ² C 3. WDT RST	64	2	128	V _{CC} : 1.8V, V _{BAT} : 1.3V	<700	Power Fail Timestamp, Event Detects (x2)	14	SOIC (SL), TSSOP (ST)	SPI (10 MHz)
	MCP795W1X	+1 ppm/±255 ppm	2 (0.01 sec)	✓	1. CLK 2. I ² C 3. WDT RST	64	1	128	V _{CC} : 1.8V, V _{BAT} : 1.3V	<700	Power Fail Timestamp, Event Detects (x2)	14	SOIC (SL), TSSOP (ST)	
	MCP795B2X	+1 ppm/±255 ppm	2 (0.01 sec)	✓	1. CLK 2. I ² C 3. WDT RST	64	2	128	V _{CC} : 1.8V, V _{BAT} : 1.3V	<700	Power Fail Timestamp, Event Detects (x2), 32 KHz Boot Clock	14	SOIC (SL), TSSOP (ST)	
	MCP795B1X	+1 ppm/±255 ppm	2	✓	1. CLK 2. I ² C 3. WDT RST	64	1	128	V _{CC} : 1.8V, V _{BAT} : 1.3V	<700	Power Fail Timestamp, Event Detects (x2), 32 KHz Boot Clock	14	SOIC (SL), TSSOP (ST)	

- All part numbers with an "X" have 3 ID programming options: 0 = Blank ID; 1 = EUI-48™ MAC Address; 2 = EUI-64™ MAC Address
- The Power Fail Timestamp in all RTCCs occur at Battery Switchover.

Serial Memory Products

Bus	Product	Released (R) Not Released (NR)	Density	Organization	Max. Clock Frequency	Operating Voltage	Temperature Range	EW Endurance (Minimum)	Data Retention (Minimum)	Max. Write Speeds	Max. Standby Current (@±5V, 85°C)	Write Protect		Protected Array Size	High Temperature (T50°C)	Special/Unique Features	Packages	Bus
												Hardware	Software					
Serial EEPROM																		
UNI/O™ Bus	11XX010	R	1 Kb	x8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	-	✓	W, ½, ¼	-	Single I/O for all clock, data, control and write protection	3-SOT-23 (TT), SOIC (SN), PDIP (P), DFN (MNY), MSOP (MS), TO-92 (TO), WLCSP (CS)	UNI/O™ Bus
	11XX020	R	2 Kb	x8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	-	✓	W, ½, ¼	-	Single I/O for all clock, data, control and write protection	3-SOT-23 (TT), SOIC (SN), PDIP (P), DFN (MNY), MSOP (MS), TO-92 (TO), WLCSP (CS)	
	11XX040	R	4 Kb	x8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	-	✓	W, ½, ¼	-	Single I/O for all clock, data, control and write protection	3-SOT-23 (TT), SOIC (SN), PDIP (P), DFN (MNY), MSOP (MS), TO-92 (TO), WLCSP (CS)	
	11XX080	R	8 Kb	x8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	-	✓	W, ½, ¼	-	Single I/O for all clock, data, control and write protection	3-SOT-23 (TT), SOIC (SN), PDIP (P), DFN (MNY), MSOP (MS), TO-92 (TO), WLCSP (CS)	
	11XX160	R	16 Kb	x8	100 kHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	-	✓	W, ½, ¼	-	Single I/O for all clock, data, control and write protection	3-SOT-23 (TT), SOIC (SN), PDIP (P), DFN (MNY), MSOP (MS), TO-92 (TO), WLCSP (CS)	
I ² C™	24XX00	R	128 b	x8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	4 ms	1 µA	-	-	-	-	100 KHz operation from 1.7V to 4.5V	SOIC (SN), TSSOP (ST), 5-SOT-23 (OT), DFN (MC), PDIP (P)	I ² C™
	24XX01B/014	R	1 Kb	x8	400 kHz	1.7V-5.5V 1.5V-3.6V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	-	W, ½	✓	Address pin option - connect up to 8 devices on bus, Very low voltage option	SOIC (SN), TSSOP (ST), PDIP (P), 5-SOT-23 (OT), DFN (MNY), MSOP (MS), SC70 (LT)	
	24XX02B/024	R	2 Kb	x8	400 kHz	1.7V-5.5V 1.5V-3.6V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W, ½	-	Address pin option - connect up to 8 devices on bus, Very low voltage option	SOIC (SN), TSSOP (ST), PDIP (P), 5-SOT-23 (OT), DFN (MNY), MSOP (MS), SC70 (LT)	
	34XX02	R	2 Kb	x8	1 MHz	1.7V-5.5V 1.5V-3.6V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½	-	1 MHz @ 2.5V, Permanent and restable software WP - DIMM-DDR2/3	SOIC (SN), TSSOP (ST), PDIP (P), 6-SOT-23 (OT), DFN (MNY), MSOP (MS)	
	24XX04B	R	4 Kb	x8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W, ½	-	400 KHz @ 2.5V, 16 byte page write buffer, No address pins	SOIC (SN), PDIP (P), TSSOP (ST), 5-SOT-23 (OT), DFN (MNY), MSOP (MS), WLCSP (CS)	
	24XX08B	R	8 Kb	x8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W, ½	-	400 KHz @ 2.5V, 16 byte page write buffer, No address pins	SOIC (SN), TSSOP (ST), 5-SOT-23 (OT), PDIP (P), DFN (MNY), MSOP (MS)	
	24XX16B	R	16 Kb	x8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W, ½	-	400 KHz @ 2.5V, 16 byte page write buffer, No address pins	SOIC (SN), TSSOP (ST), PDIP (P), 5-SOT-23 (OT), DFN (MNY), MSOP (MS), WLCSP (CS)	
	24XX32A	R	32 Kb	x8	400 kHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W, ¼	-	400 KHz @ 2.5V, 32 byte page write buffer, connect up to 8 devices on bus	SOIC (SN), TSSOP (ST), PDIP (P), 5-SOT-23 (OT), DFN (MNY), MSOP (MS), WLCSP (CS)	
	24XX64/65	R	64 Kb	x8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M, 10M	200 Years	5 ms	1 µA	✓	-	W, ¼	-	1 MHz @ 2.5V, 32/64 byte page, Relocatable 4 Kb block with 10M cycles endurance	SOIC (SN), TSSOP (ST), PDIP (P), 5-SOT-23 (OT), DFN (MNY), MSOP (MS), WLCSP (CS)	
	24XX128	R	128 Kb	x8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W	-	1 MHz @ 2.5V, 64 byte page, connect up to 8 devices on bus	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MNY), MSOP (MS), WLCSP (CS)	
	24XX256	R	256 Kb	x8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W	-	1 MHz @ 2.5V, 64 byte page, connect up to 8 devices on bus	SOIC (SN), TSSOP (ST), SOJ (SM), PDIP (P), DFN (MF), MSOP (MS), WLCSP (CS)	
	24XX512	R	512 Kb	x8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	1 µA	✓	-	W	-	1 MHz @ 2.5V, 128 byte page, connect up to 8 devices on bus	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MF), SOJ (SM), WLCSP (CS)	
	24XX1025/26	R	1 Mb	x8	1 MHz	1.7V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	5 µA	✓	-	W	-	1 MHz @ 2.5V, 128 byte page, connect up to 4 devices on bus	SOIC (SN), TSSOP (ST), PDIP (P), SOJ (SM)	

- All devices are Pb-Free and RoHS compliant.
- ESD protection > 4 kV (HBM); >400V (MM) on all pins.
- Write Protect (WP): W = Whole Array, ½ = Half Array, ¼ = Quarter Array.
- Factory program and unique ID options available.
- Die and wafer options available on all devices.

AEC-Q100 Qualified AEC-Q100 Capable

Serial Memory Products

Bus	Product	Released (R) Not Released (NR)	Density	Organization	Max. Clock Frequency	Operating Voltage	Temperature Range	EW Endurance (Minimum)	Data Retention (Minimum)	Max. Write Speeds	Max. Standby Current (@5.5V, 85°C)	Write Protect		Protected Array Size	High Temperature (150°C)	Special/Unique Features	Packages	Bus
												Hardware	Software					
Serial EEPROM (Cont.)																		
Microwire	93XX46A/B/C	R	1 Kb	x8/x16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 µA	-	-	-	-	ORG pin to select word size on 46C version	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	Microwire
	93XX56A/B/C	R	2 Kb	x8 / x16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 µA	-	-	-	-	ORG pin to select word size in 56C version	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	
	93XX66A/B/C	R	4 Kb	x8 / x16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 µA	-	-	-	-	ORG pin to select word size in 66C version	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	
	93XX76A/B/C	R	8 Kb	x8 / x16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 µA	✓	-	W	-	ORG pin to select word size in 76C version	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	
	93XX86A/B/C	R	16 Kb	x8 / x16	3 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	1 µA	✓	-	W	-	ORG pin to select word size in 86C version	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	
SPI	25XX010A	R	1 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	5 MHz @ 2.5V, Status register, 16 byte page	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	SPI
	25XX020A	R	2 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	5 MHz @ 2.5V, Status register, 16 byte page, Unique EUI-48™/EUI-64™ MAC address option available	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	
	25XX040A	R	4 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	5 MHz @ 2.5V, Status register, 16 byte page	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MC), MSOP (MS), 6-SOT-23 (OT)	
	25XX080C/D	R	8 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	16/32 byte page, 5 MHz @ 2.5V, Status register	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MNY), MSOP (MS)	
	25XX160C/D	R	16 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	16/32 byte page, 5 MHz @ 2.5V, Status register	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MNY), MSOP (MS)	
	25XX320A	R	32 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	5 MHz @ 2.5V, Status register, 32 byte page	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MNY), MSOP (MS)	
	25XX640A	R	64 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	5 MHz @ 2.5V, Status register, 32 byte page	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MNY, MF), MSOP (MS)	
	25XX128	R	128 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	5 MHz @ 2.5V, Status register, 64 byte page	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MF)	
	25XX256	R	256 Kb	x8	10 MHz	1.8V-5.5V	-40°C to +150°C	1M	200 Years	5 ms	1 µA	✓	✓	W, ½, ¼	✓	5 MHz @ 2.5V, Status register, 64 byte page	SOIC (SN), TSSOP (ST), PDIP (P), DFN (MF), SOU (SM)	
	25XX512	R	512 Kb	x8	20 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	5 ms	10 µA	✓	✓	W, ½, ¼	-	10 MHz @ 2.5V, Deep power down, Status register, Page/Sector/Chip erase	SOIC (SN), PDIP (P), DFN (MF), SOU (SM)	
25XX1024	R	1 Mb	x8	20 MHz	1.8V-5.5V	-40°C to +125°C	1M	200 Years	6 ms	12 µA	✓	✓	W, ½, ¼	-	10 MHz @ 2.5V, Deep power down, Status register, Page/Sector/Chip erase	PDIP (P), DFN (MF), SOU (SM)		

1. All devices are Pb-Free and RoHS compliant.
2. ESD protection > 4 kV (HBM); >400V (MM) on all pins.
3. Write Protect (WP): W = Whole Array, ½ = Half Array, ¼ = Quarter Array.
4. Factory program and unique ID options available.
5. Die and wafer options available on all devices.

SST Serial Flash Memory

Bus	Product	Released (R) Not Released (NR)	Density	Organization	Max. Clock Frequency	Operating Voltage	Temperature Range	EW Endurance (Typical)	Data Retention (Minimum)	Write Speed (Typical)	Max. Standby Current	Write Protect			PPAP Availability	Description	Packages*	Bus
												Hardware	Software	Protected Array Size				
x1	SST25VF040B	R	4 Mb	512K x 8	50 MHz	2.7-3.6V	-40°C to 85°C	100,000 cycles	100 years	7 µs (Word Program)	5 µA	✓	✓	Various	N	512K x 8, 4 KB Sector	8-SOIC, WSON	x1
	SST25VF080B	R	8 Mb	1M x 8	50 MHz	2.7-3.6V	-40°C to 85°C	100,000 cycles	100 years	7 µs (Word Program)	5 µA	✓	✓	Various	N	1M x 8, 4 KB Sector	8-SOIC, WSON	
	SST25VF016B	R	16 Mb	2M x 8	50 MHz	2.7-3.6V	-40°C to 85°C	100,000 cycles	100 years	7 µs (Word Program)	5 µA	✓	✓	Various	N	2M x 8, 4 KB Sector	8-SOIC, WSON	

*Only standard packages are listed here. Please inquire with your local sales office for devices in die form or in chip-scale packages.

AEC-Q100 Qualified AEC-Q100 Capable

SST Parallel Flash Memory

Bus	Product	Released (R) Not Released (NR)	Density	Organization	Read Access Speed	Operating Voltage	Temperature Range	E/W Endurance (Typical)	Data Retention (Minimum)	Write Speed (Typical)	Max. Standby Current	Write Protect			PPAP Availability	Description	Packages*
												Hardware	Software	Protected Array Size			
x16	SST39VF400A	R	4 Mb	256K x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	14 μs (Word Program)	3 μA	-	-	N/A	N	256K x16, 2 KW Sector	48-TFBGA, TSOP
	SST39WF400B	R	4 Mb	256K x16	70 ns	1.65-1.95V	-40°C to +85°C	100,000 cycles	100 years	28 μs (Word Program)	5 μA	-	-	N/A	2nd half 2013	256K x 16, 2K/32 KW Sector	48-TFBGA
	SST39VF800A	R	8 Mb	512K x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	14 μs (Word Program)	3 μA	-	-	N/A	N	512K x 16, 2 KW Sector	48-TFBGA, TSOP
	SST39WF800B	R	8 Mb	512K x16	70 ns	1.65-1.95V	-40°C to +85°C	100,000 cycles	100 years	28 μs (Word Program)	5 μA	-	-	N/A	2nd half 2013	512K x 16, 2K/32 KW Sector	48-TFBGA
	SST39VF801C	R	8 Mb	512K x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	8 KW	2nd half 2013	512K x 16, Bottom Boot, Standard Command Sets and Blocks	48-TFBGA, TSOP
	SST39VF802C	R	8 Mb	512K x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	8 KW	2nd half 2013	512K x 16, Top Boot, Standard Command Sets and Blocks	48-TFBGA, TSOP
	SST39VF1601	R	16 Mb	1M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	32 KW	N	1M x 16, 2K/32 KW Sector, Bottom Boot	48-TFBGA, TSOP
	SST39VF1601C	R	16 Mb	1M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	8 KW	2nd half 2013	1M x 16, Bottom Boot, Standard Command Sets and Blocks	48-TFBGA, TSOP
	SST39VF1602	R	16 Mb	1M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	32 KW	N	1M x 16, 2K/32 KW Sector, Top Boot	48-TFBGA, TSOP
	SST39VF1602C	R	16 Mb	1M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	8 KW	2nd half 2013	1M x 16, Top Boot, Standard Command Sets and Blocks	48-TFBGA, TSOP
	SST39WF1601	R	16 Mb	1M x16	70 ns	1.65-1.95V	-40°C to +85°C	100,000 cycles	100 years	28 μs (Word Program)	5 μA	✓	-	32 KW	2nd half 2013	1M x 16, 2K/32 KW Sector, Bottom Boot	48-TFBGA
	SST39WF1602	R	16 Mb	1M x16	70 ns	1.65-1.95V	-40°C to +85°C	100,000 cycles	100 years	28 μs (Word Program)	5 μA	✓	-	32 KW	2nd half 2013	1M x 16, 2K/32 KW Sector, Top Boot	48-TFBGA
	SST39VF3201	R	32 Mb	2M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	32 KW	N	2M x 16, 2K/32 KW Sector, Bottom Boot	48-TFBGA, TSOP
	SST39VF3202	R	32 Mb	2M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	32 KW	N	2M x 16, 2K/32 KW Sector, Top Boot	48-TFBGA, TSOP
	SST39VF6401B	R	64 Mb	4M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	32 KW	N	4M x 16, 2K/32 KW Sector, Bottom Boot	48-TFBGA, TSOP
	SST39VF6402B	R	64 Mb	4M x16	70 ns	2.7-3.6V	-40°C to +85°C	100,000 cycles	100 years	7 μs (Word Program)	3 μA	✓	-	32 KW	N	4M x 16, 2K/32 KW Sector, Top Boot	48-TFBGA, TSOP

*Only standard packages are listed here. Please inquire with your local sales office for devices in die form or in chip-scale packages.

AEC-Q100 Qualified AEC-Q100 Capable

Terms and Definitions

1 KB	1024 bytes	DSM	Data Signal Modulator	MR/Mid-Range	14-bit instruction word – 35 instructions
1 Kw	1024 words	dsPIC*	16-bit Core with DSP	MSSP/SSP	Master/Synchronous Serial Port (I ² C & SPI Peripheral)
18F/PIC18	16-bit instruction word – 75/83 instructions	ECAN	Enhanced Controller Area Network Electrically Erasable	mTouch™	Proprietary Touch Sensing Technology
AEC-Q100 Qualified	Device has successfully passed AEC-Q100 qualification requirements	EEPROM	Programmable Read Only Memory	NCO	Numerically Controlled Oscillator
AEC-Q100 Capable	Device is manufactured in a process that allows it to meet AEC-Q100 qualification requirements	EFT	Electrical Fast Transient	PIC24	16-bit Core
ADC	Analog-to-Digital Converter	EMC	Electromagnetic Compatibility	PIC32	32-bit Core
AUSART	Addressable Universal Synchronous Asynchronous Receiver Transceiver	EMI	Electromagnetic Interference	PLVD	Programmable Low Voltage Detect
BL/Baseline	12-bit instruction word – 33 instructions	EMR/Enhanced-MidRange	14-bit instruction word – 49 instructions (denoted as PIC1XF1XXX)	POR/POOR	Power ON Reset/Power ON/OFF Reset
BOR/PBOR	Brown Out Reset/Programmable Brown Out Reset	ESD	Electrostatic Discharge	PSMC	Programmable Switch Mode Controller
CAP/ECCP	Capture Compare PWM/Enhanced Capture Compare PWM	EUSART	Enhanced Universal Synchronous Asynchronous Receiver Transceiver	PWM	Pulse Width Modulation
CLC	Configurable Logic Cell	EWDT/WDT	Extended Watch Dog Timer/Watch Dog Timer	RAM	Random Access Memory
COG	Complementary Output Generator	HV	High Voltage	RTCC	Real-Time Clock Calendar
Comp	Capacitive Sensing Implemented via Comparator	ICD	In-Circuit Debug	Source/Sink Current	All Products Support 25 mA per I/O
CRC	Cyclical Redundancy Check	ICE	In-Circuit Emulation	SR Latch	Set Reset Latch
CSM	mTouch™ – Capacitive Sensing Module	ICSP™	In-Circuit Serial Programming™	SRAM	Static Random Access Memory
CSP	Chip Scale Package	IDE	Integrated Development Environment	SPI	Serial Peripheral Interface
CTMU	mTouch – Charge Time Measurement Unit	LCD	Liquid Crystal Display	T1G	Timer 1 Gate
CVD	Charge Voltage Divide (Capacitive Sensing Implemented via ADC)	LDO	Low Drop-Out voltage regulator	USART	Universal Synchronous Asynchronous Receiver Transceiver
CWG	Complementary Waveform Generator	LF	Low Power Flash	USB	Universal Serial Bus
DAC	Digital-to-Analog Converter	M ² C/I ² C	Master Inter-Integrated Circuit bus/Inter-Integrated Circuit bus	USB (Full Speed)	12 Mb/s Data Rate
DDS	Direct Digital Synthesis	MIPS	Million Instructions Per Second	USB OTG	USB On-The-Go
				XLP	nanoWatt XLP eXtreme Low Power Technology

Product Packages

Small Outline	Dual Flat No Lead DFN	Quad Flat No Lead QFN	Plastic Shrink Small Outline SSOP	Plastic Thin Shrink Small Outline TSSOP
Bumped Die (WLCSP)	3-lead DDPAK (EB)	8-lead DFN (MC) 2x3x0.9 mm	8-lead MSOP (MS)	8-lead TSSOP (ST)
Die/Wafer (WLCSP)	5-lead DDPAK (ET)	8-lead TDFN (MN) 2x3x0.75 mm	10-lead MSOP (UN)	14-lead TSSOP (ST)
3-lead SC70 (LB)	3-lead SOT-89 (MB)	8-lead UDFN (MU) 2x3x0.5 mm	16-lead QSOP (QR)	20-lead TSSOP (ST)
5-lead SC70 (LT)	3-lead TO-92 (TO/ZB)	8-lead DFN (MF) 3x3x0.9 mm	20-lead SSOP (SS)	
3-lead SOT-23 (TT/CB)	5-lead TO-220 (AT)	8-lead DFN (MD) 4x4x0.9 mm	28-lead SSOP (SS)	
5-lead SOT-23 (OT)		8-lead DFN (MF) 4x4x0.9 mm		
6-lead SOT-23 (OT/CH)		8-lead DFN (MF) 6x5x0.9 mm	28-lead QFN (MQ) 5x5x0.9 mm	
3-SOT-223 (DB)		28-lead QFN (MM & ML) 6x6x0.9 mm	28-lead SSOP (SS)	
4-lead SOT-143 (RC)		40-lead UQFN (MV) 5x5x0.5 mm		
		44-lead QFN (ML) 8x8x0.9 mm		
		64-lead QFN (MR) 9x9x0.9 mm		

Packages are shown approximate size.

Additional packages are available – contact your local Microchip sales office for additional information.

For detailed dimensions, view our Package Drawing and Dimensions Specification at: www.microchip.com/packaging

Product Packages

Plastic Small Outline SOIC



8-lead SOIC (SN)



8-lead SOIC (SM)



14-lead SOIC (SL)



16-lead SOIC (SL)



18-lead SOIC (SO)



20-lead SOIC (SO)



28-lead SOIC (SO)

Plastic Thin Quad Flatpack TQFP



44-lead TQFP (PT)
10x10x1 mm



64-lead TQFP (PT)
10x10x1 mm



64-lead TQFP (PF)
14x14x1 mm



80-lead TQFP (PT)
12x12x1 mm



80-lead TQFP (PF)
14x14x1 mm



100-lead TQFP (PT)
12x12x1 mm



100-lead TQFP (PF)
14x14x1 mm



144-lead TQFP (PH)
16x16x1 mm

Plastic Quad Flatpack QFP



32-lead LQFP (LQ)
7x7x1.4 mm



44-lead MQFP (PQ)
10x10x2 mm

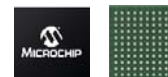


144-lead LQFP (PL)
20x20x1.4 mm

Ball Grid Array BGA



100-ball BGA (BG)
10x10x1.1 mm



121-ball BGA (BG)
10x10x0.8 mm

Plastic Dual In-Line PDIP



8-lead PDIP (P)



14-lead PDIP (P)



18-lead PDIP (P)



20-lead PDIP (P)



24-lead PDIP (P)



28-lead SPDIP (SP)



40-lead PDIP (P)

Packages are shown approximate size.

Additional packages are available – contact your local Microchip sales office for additional information.

For detailed dimensions, view our Package Drawing and Dimensions Specification at: www.microchip.com/packaging

Support

Microchip is committed to supporting its customers in developing products faster and more efficiently. We maintain a worldwide network of field applications engineers and technical support ready to provide product and system assistance. In addition, the following service areas are available at www.microchip.com:

- **Support** link provides a way to get questions answered fast: <http://support.microchip.com>
- **Sample** link offers evaluation samples of any Microchip device: <http://sample.microchip.com>
- **Forum** link provides access to knowledge base and peer help: <http://forum.microchip.com>
- **Buy** link provides locations of Microchip Sales Channel Partners: www.microchip.com/sales

Sales Office Listing

AMERICAS

Atlanta

Tel: 678-957-9614

Boston

Tel: 774-760-0087

Chicago

Tel: 630-285-0071

Cleveland

Tel: 216-447-0464

Dallas

Tel: 972-818-7423

Detroit

Tel: 248-538-2250

Indianapolis

Tel: 317-773-8323

Los Angeles

Tel: 949-462-9523

Santa Clara

Tel: 408-961-6444

Toronto

Mississauga, Ontario

Tel: 905-673-0699

EUROPE

Austria - Wels

Tel: 43-7242-2244-39

Denmark - Copenhagen

Tel: 45-4450-2828

France - Paris

Tel: 33-1-69-53-63-20

Germany - Munich

Tel: 49-89-627-144-0

Italy - Milan

Tel: 39-0331-742611

Netherlands - Drunen

Tel: 31-416-690399

Spain - Madrid

Tel: 34-91-708-08-90

UK - Wokingham

Tel: 44-118-921-5869

Training

If additional training interests you, then Microchip can help. We continue to expand our technical training options, offering a growing list of courses and in-depth curriculum locally, as well as significant online resources – whenever you want to use them.

- Technical Training Centers: www.microchip.com/training
- MASTERS Conferences: www.microchip.com/masters
- Worldwide Seminars: www.microchip.com/seminars
- eLearning: www.microchip.com/webseminars
- Resources from our Distribution and Third Party Partners www.microchip.com/training

ASIA/PACIFIC

Australia - Sydney

Tel: 61-2-9868-6733

China - Beijing

Tel: 86-10-8569-7000

China - Chengdu

Tel: 86-28-8665-5511

China - Chongqing

Tel: 86-23-8980-9588

China - Hangzhou

Tel: 86-571-2819-3187

China - Hong Kong SAR

Tel: 852-2401-1200

China - Nanjing

Tel: 86-25-8473-2460

China - Qingdao

Tel: 86-532-8502-7355

China - Shanghai

Tel: 86-21-5407-5533

China - Shenyang

Tel: 86-24-2334-2829

China - Shenzhen

Tel: 86-755-8203-2660

China - Wuhan

Tel: 86-27-5980-5300

China - Xiamen

Tel: 86-592-2388138

China - Xian

Tel: 86-29-8833-7252

China - Zhuhai

Tel: 86-756-3210040

ASIA/PACIFIC

India - Bangalore

Tel: 91-80-3090-4444

India - New Delhi

Tel: 91-11-4160-8631

India - Pune

Tel: 91-20-2566-1512

Japan - Osaka

Tel: 81-6-6152-7160

Japan - Yokohama

Tel: 81-45-471- 6166

Korea - Daegu

Tel: 82-53-744-4301

Korea - Seoul

Tel: 82-2-554-7200

Malaysia - Kuala Lumpur

Tel: 60-3-6201-9857

Malaysia - Penang

Tel: 60-4-227-8870

Philippines - Manila

Tel: 63-2-634-9065

Singapore

Tel: 65-6334-8870

Taiwan - Hsin Chu

Tel: 886-3-5778-366

Taiwan - Kaohsiung

Tel: 886-7-2137828

Taiwan - Taipei

Tel: 886-2-2500-6610

Thailand - Bangkok

Tel: 66-2-694-1351

11/29/11

Microcontrollers • Digital Signal Controllers • Analog • Memory • Wireless

Information subject to change. The Microchip name and logo, the Microchip logo, dsPIC and PIC are registered trademarks and ICSP, In-Circuit Serial Programming and mTouch are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries. All other trademarks mentioned herein are property of their respective companies. © 2012, Microchip Technology Incorporated. All Rights Reserved. Printed in the U.S.A. 2/12

DS01320C




MICROCHIP
www.microchip.com

Microchip Technology Inc.
2355 W. Chandler Blvd.
Chandler, AZ 85224-6199